Page 7 of 7

Response to Ex Parte Quayle Action

Serial No.: 09/865,612 Confirmation No.: 4697 Filed: May 25, 2001

METHODS, COMPLEXES, AND SYSTEMS FOR FORMING METAL-CONTAINING FILMS ON

SEMICONDUCTOR STRUCTURES

Remarks

The Ex Parte Quayle Action dated 5 May 2004 has been received and reviewed. The section of the previously-submitted amendment document containing the non-compliant provision ("Amendments to the Claims") is resubmitted (in its entirety) above.

Applicant respectfully requests that the application be passed on to Allowance.

Summary

The Examiner is invited to contact Applicant's Representatives, at the below-listed telephone number, if it is believed that prosecution of this application may be assisted thereby.

> Respectfully submitted for Brian A. Vaartstra

By Mueting, Raasch & Gebhardt, P.A. P.O. Box 581415 Minneapolis, MN 55458-1415

Phone: (612) 305-1220 Facsimile: (612) 305-1228

Customer Number 26813

Loren D. Albin Reg. No. 37,763

Direct Dial (612)305-1225

CERTIFICATE UNDER 37 CFR §1.8:

The undersigned hereby certifies that this paper is being transmitted by facsimile in accordance with 37 CFR §1.6(d) to the Patent and Trademark Office, addressed to Commissioner for Patents, Mail Stop Amendment, P.O. Box 1450, Alexandria, VA 22313-1450, on this 12th day of May, 2004, at 3:25pm (Central Time).